PI No. CELT/IMP/2011-12/PKP/NR/09 date: 18.01.2012

Technical Specification for Laser Micro Machining System

Pulse Energy: > 0.8 mJ @ 1 kHz

Pulse Width: < 250 fs

Wavelength: 700 – 800 nm

Wavelength bandwidth: 10 nm

TEM00 Mode

Beam divergence: < 100 micro radian

 M^2 : < 1.5

Polarization ratio: Linear

With Galvo System

XYZ automatic traverse resolution ~ 10 nm

Note: Any other micro fabrication system with glass based fabrication capability for optofluidics applications is also welcome.

Last date of sending quotation: 25th January 2012

Send your Quotation to:

P. K. Panigrahi

Head, Laser Technology Program

IIT Kanpur,